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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Jiang et al.  
Serial No.: 09/966,605  
Filing Date: 09/28/2001  
Customer No.: 23494

Art Unit: 1765  
Examiner: Vinh, Lan  
Docket No.: TI-31462  
Conf. No.: 4769

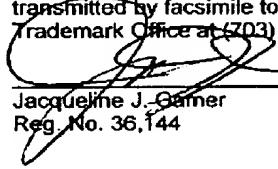
Title: IN-SITU PLASMA ASH/TREATMENT AFTER VIA ETCH OF LOW-K FILMS FOR POISON-FREE DUAL DAMASCENE TRENCH PATTERNING

AMENDMENT AFTER FINAL

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at (703) 872 - 9306 on 4/19/2004.

  
Jacqueline J. Garner  
Reg. No. 36,144

Dear Sir:

The following amendments and remarks are offered in response to the Examiner's Office Action dated 11/18/2003. They are respectfully submitted as a full and complete response to that Action.

Please amend the above-referenced application as follows:

There are no **Amendments to the Specification**.

**Amendments to the Claims** are reflected in the listing of claims that begin on page 2 of this paper.

There are no **Amendments to the Drawings**.

The **Remarks** begin on page 5.

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